Claims: What is claimed is:

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- 7. A computer system board with a plurality of shield expansion housing apparatuses for add-on expansion daughter board comprises:
 - a computer system board with plurality of on PCB shield zone a plurality of shield expansion housing cover
 - 8. The on PCB shield zone of claim 7 is a ground shield copper plate PCB area with solder able surrounding zone where the said shield expansion housing cover can be solder on to.
 - 9. The shield expansion housing cover of claim 7 is a metallic cover box with an open base that can be solder on to the solder able surrounding zone of claim 8.
- 10. An apparatus of conduct heat from high heat generate electronics on the said expansion daughter board to shield expansion zone comprises:
 - a on PCB shield zone of claim 7
- a expansion daughter board attached in to the connector/s within the said on PCB shield zone
 - a metallic shield expansion housing cover soldered on the said on PCB shield zone
 - plurality of heat conduct material mounted between and contact the daughter and
 - the said on PCB shield zone and the inside of the said metallic shield expansion housing cover
 - Heat conduct means on top of the said metallic shield expansion housing cover

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